Name of Applicant :

Date :

Signature :

**7th IEEE Electron Devices TeCchanllofloorgSypaonndsoMrasnhuipfacturing (EDTM) Conference**

***Sponsorship Application Form***

Please fill out the below application form, and send it back to the secretariat.

IEEE EDTM 2023 Secretariat

[Tel: 042-472-7460 / Fax: 042-472-7459] [E-mail: edtm2023@edtm2023.org]

1. Information of the Company

|  |  |
| --- | --- |
| Company Name |  |
| President |  | Person in Charge |  |
| Department |  |
| Address |  |
| Zip Code |  | Country |  |
| Tel |  | Fax |  |
| E-mail |  |

1. Sponsorship

|  |  |  |
| --- | --- | --- |
| Category | KRW | Apply (Check ‘O’) |
| Diamond | USD 17,000 / KRW 20,000,000 |  |
| Platinum | USD 13,000 / KRW 15,000,000 |  |
| Gold | USD 9,000 / KRW 10,000,000 |  |
| Silver | USD 5,000 / KRW 6,000,000 |  |
| Bronze | USD 2,500 / KRW 3,000,000 |  |

1. Account Information

|  |  |
| --- | --- |
| Account Holder | GENICOM CO., LTD 2023 IEEE EDTM |
| Account Number | 661-910018-97105 |
| Bank Name | KEB HANA BANK |
| Swift Code | KOEXKRSE |
| Bank Address | 35, EULJI-RO, JUNG-GU, SEOUL, SOUTH KOREA |
| Branch | Jeonmin-Dong KEB HANA BANK |